

HD74HC151

1-of-8-line Data Selector/Multiplexer

REJ03D0575-0200
 (Previous ADE-205-449)
 Rev.2.00
 Oct 11, 2005

Description

HD74HC151 selects one of the 8 data sources, depending on the address presented on the A, B and C inputs. It features both true (Y) and complement (W) outputs. The strobe input must be at a low logic level to enable this multiplexer. A high logic level at the strobe forces the W output high and the Y output low.

Features

- High Speed Operation: t_{pd} (Any D to Y or W) = 18 ns typ ($C_L = 50$ pF)
- High Output Current: Fanout of 10 LSTTL Loads
- Wide Operating Voltage: $V_{CC} = 2$ to 6 V
- Low Input Current: 1 μ A max
- Low Quiescent Supply Current: I_{CC} (static) = 4 μ A max ($T_a = 25^\circ\text{C}$)
- Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74HC151P	DILP-16 pin	PRDP0016AE-B (DP-16FV)	P	—
HD74HC151FPEL	SOP-16 pin (JEITA)	PRSP0016DH-B (FP-16DAV)	FP	EL (2,000 pcs/reel)
HD74HC151RPEL	SOP-16 pin (JEDEC)	PRSP0016DG-A (FP-16DNV)	RP	EL (2,500 pcs/reel)

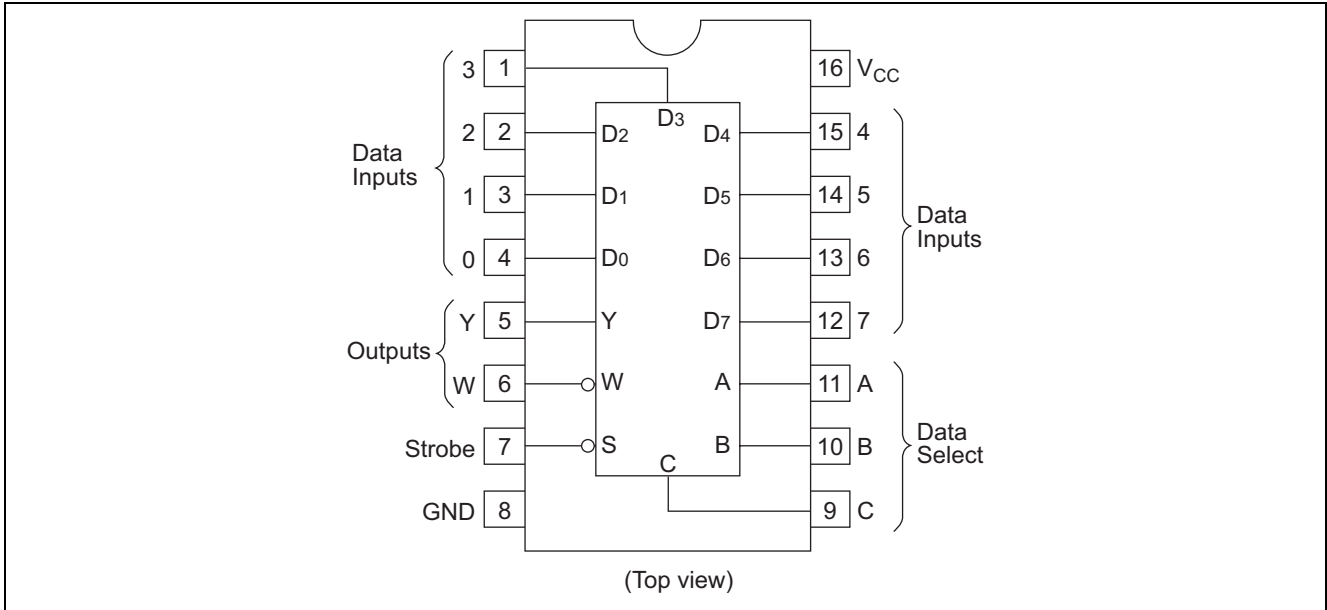
Note: Please consult the sales office for the above package availability.

Function Table

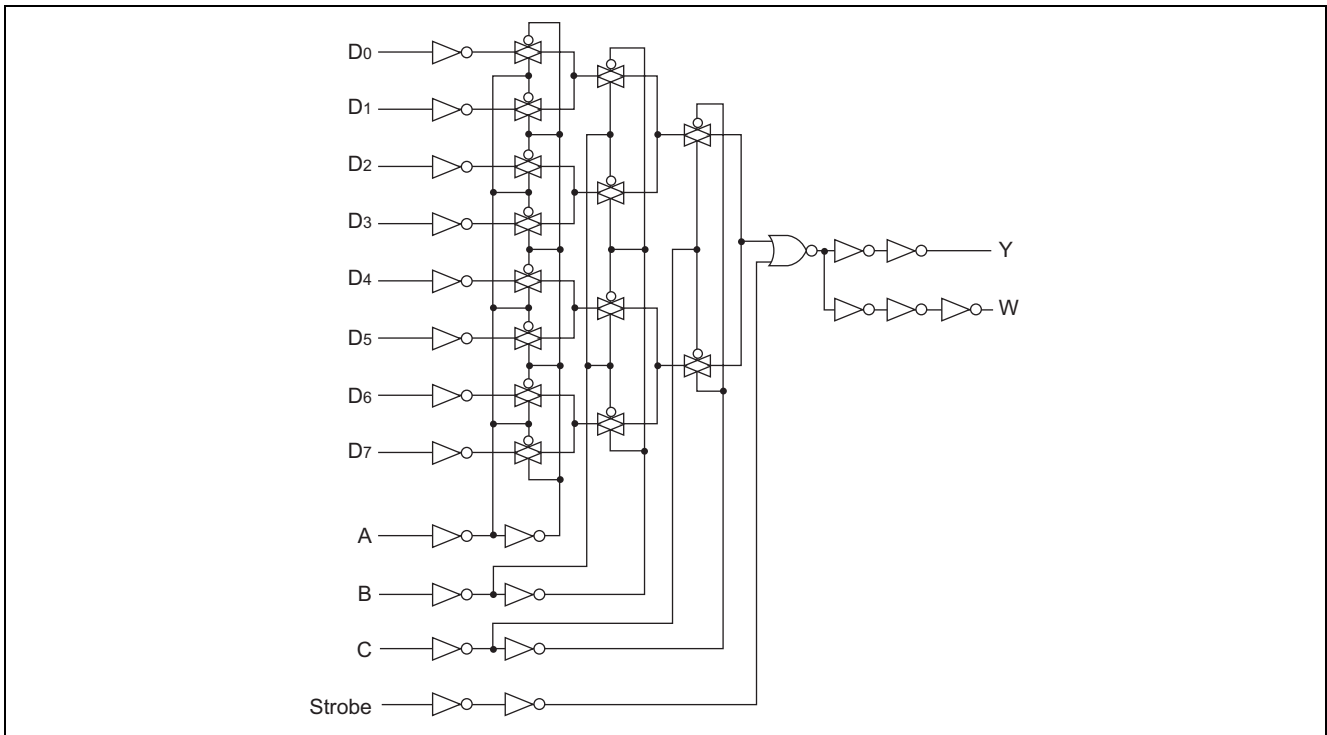
Inputs				Outputs	
Select			Strobe S	Y	W
C	B	A			
X	X	X	H	L	H
L	L	L	L	D_0	\bar{D}_0
L	L	H	L	D_1	\bar{D}_1
L	H	L	L	D_2	\bar{D}_2
L	H	H	L	D_3	\bar{D}_3
H	L	L	L	D_4	\bar{D}_4
H	L	H	L	D_5	\bar{D}_5
H	H	L	L	D_6	\bar{D}_6
H	H	H	L	D_7	\bar{D}_7

H : High level
 L : Low level
 X : Irrelevant

Pin Arrangement



Logic Diagram



Absolute Maximum Ratings

Item	Symbol	Rating	Unit
Supply voltage range	V_{CC}	-0.5 to +7.0	V
Input voltage	V_{IN}	-0.5 to $V_{CC} + 0.5$	V
Output voltage	V_{OUT}	-0.5 to $V_{CC} + 0.5$	V
Output current	I_{OUT}	± 25	mA
DC current drain per V_{CC} , GND	I_{CC} , I_{GND}	± 50	mA
DC input diode current	I_{IK}	± 20	mA
DC output diode current	I_{OK}	± 20	mA
Power dissipation per package	P_T	500	mW
Storage temperature	T_{stg}	-65 to +150	°C

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V_{CC}	2 to 6	V	
Input / Output voltage	V_{IN} , V_{OUT}	0 to V_{CC}	V	
Operating temperature	T_a	-40 to 85	°C	
Input rise / fall time ^{*1}	t_r , t_f	0 to 1000	ns	$V_{CC} = 2.0$ V
		0 to 500		$V_{CC} = 4.5$ V
		0 to 400		$V_{CC} = 6.0$ V

Note: 1. This item guarantees maximum limit when one input switches.

Waveform: Refer to test circuit of switching characteristics.

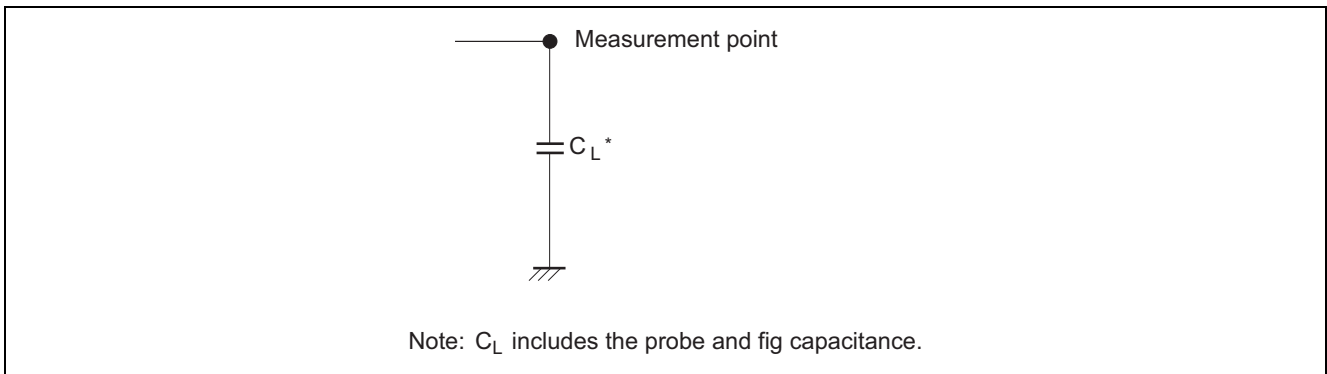
Electrical Characteristics

Item	Symbol	V_{CC} (V)	$T_a = 25^\circ\text{C}$			$T_a = -40$ to $+85^\circ\text{C}$		Unit	Test Conditions	
			Min	Typ	Max	Min	Max			
Input voltage	V_{IH}	2.0	1.5	—	—	1.5	—	V		
		4.5	3.15	—	—	3.15	—			
		6.0	4.2	—	—	4.2	—			
	V_{IL}	2.0	—	—	0.5	—	0.5	V		
		4.5	—	—	1.35	—	1.35			
		6.0	—	—	1.8	—	1.8			
Output voltage	V_{OH}	2.0	1.9	2.0	—	1.9	—	V	$V_{in} = V_{IH}$ or V_{IL}	$I_{OH} = -20$ μA
		4.5	4.4	4.5	—	4.4	—			$I_{OH} = -4$ mA
		6.0	5.9	6.0	—	5.9	—			$I_{OH} = -5.2$ mA
		4.5	4.18	—	—	4.13	—			
		6.0	5.68	—	—	5.63	—			
	V_{OL}	2.0	—	0.0	0.1	—	0.1	V	$V_{in} = V_{IH}$ or V_{IL}	$I_{OL} = 20$ μA
		4.5	—	0.0	0.1	—	0.1			
		6.0	—	0.0	0.1	—	0.1			
		4.5	—	—	0.26	—	0.33			$I_{OL} = 4$ mA
		6.0	—	—	0.26	—	0.33			$I_{OL} = 5.2$ mA
Input current	I_{in}	6.0	—	—	± 0.1	—	± 1.0	μA	$V_{in} = V_{CC}$ or GND	
Quiescent supply current	I_{CC}	6.0	—	—	4.0	—	40	μA	$V_{in} = V_{CC}$ or GND, $I_{out} = 0$ μA	

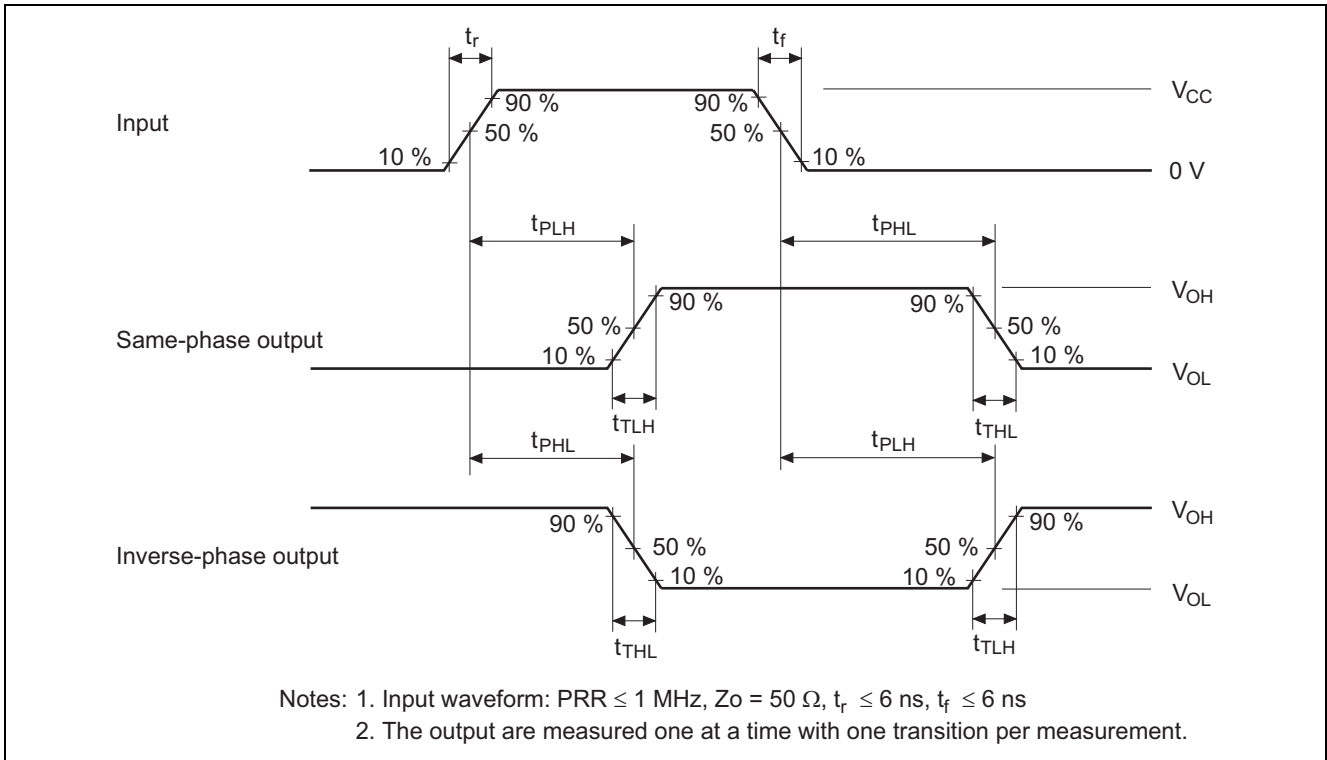
Switching Characteristics ($C_L = 50\text{ pF}$, Input $t_r = t_f = 6\text{ ns}$)

Item	Symbol	V_{CC} (V)	$T_a = 25^\circ\text{C}$			$T_a = -40\text{ to }+85^\circ\text{C}$		Unit	Test Conditions
			Min	Typ	Max	Min	Max		
Propagation delay time	t_{PLH}, t_{PHL}	2.0	—	—	205	—	255	ns	A, B or C to Y
		4.5	—	18	41	—	51		
		6.0	—	—	35	—	43		
	t_{PLH}, t_{PHL}	2.0	—	—	185	—	230	ns	A, B or C to W
		4.5	—	18	37	—	46		
		6.0	—	—	31	—	39		
	t_{PLH}, t_{PHL}	2.0	—	—	175	—	220	ns	Any D to Y
		4.5	—	16	35	—	44		
		6.0	—	—	30	—	37		
	t_{PLH}, t_{PHL}	2.0	—	—	170	—	215	ns	Any D to W
		4.5	—	16	34	—	43		
		6.0	—	—	29	—	37		
	t_{PLH}, t_{PHL}	2.0	—	—	125	—	155	ns	Strobe to Y
		4.5	—	10	25	—	31		
		6.0	—	—	21	—	26		
	t_{PLH}, t_{PHL}	2.0	—	—	115	—	145	ns	Strobe to W
		4.5	—	10	23	—	29		
		6.0	—	—	20	—	25		
Output rise/fall time	t_{TLH}, t_{THL}	2.0	—	—	75	—	95	ns	
		4.5	—	5	15	—	19		
		6.0	—	—	13	—	16		
Input capacitance	C_{in}	—	—	5	10	—	10	pF	

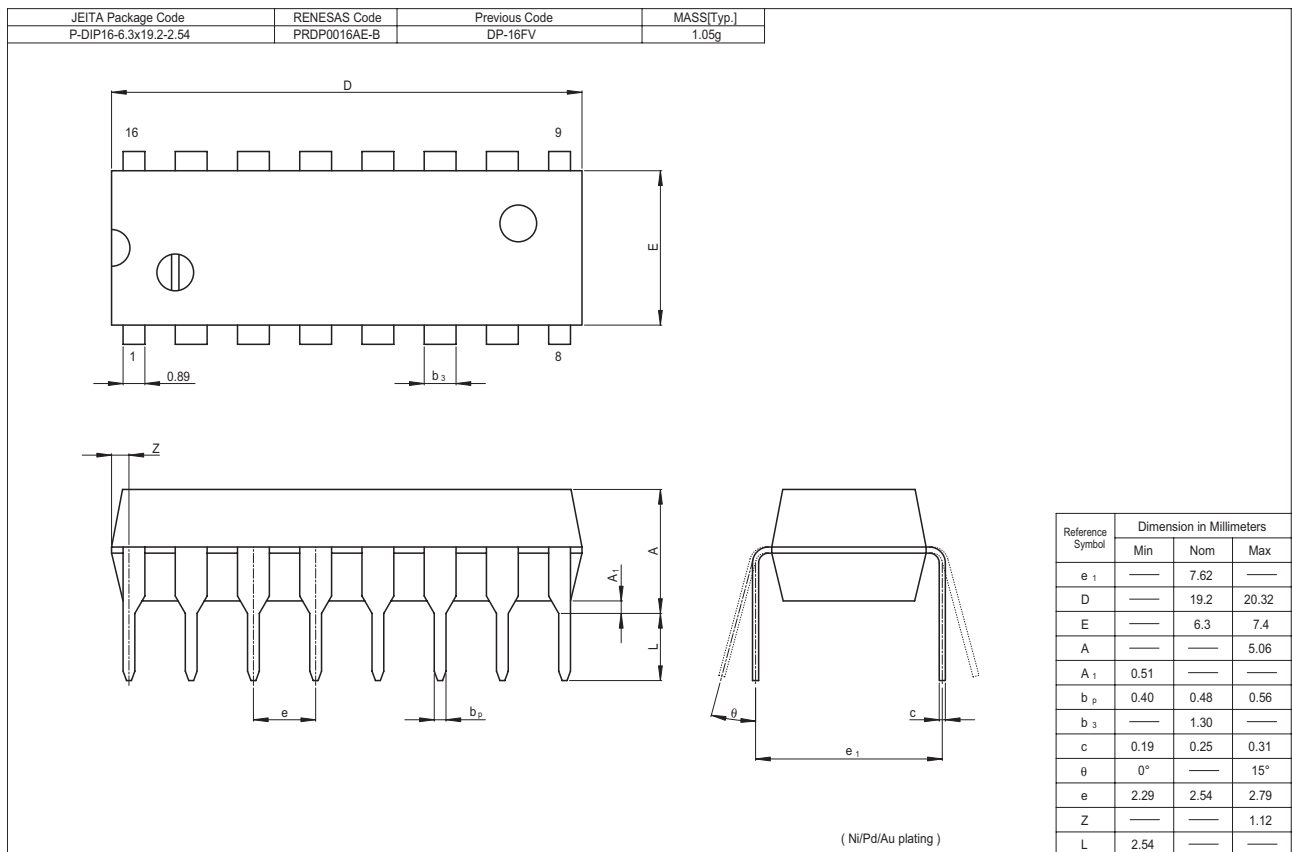
Test Circuit



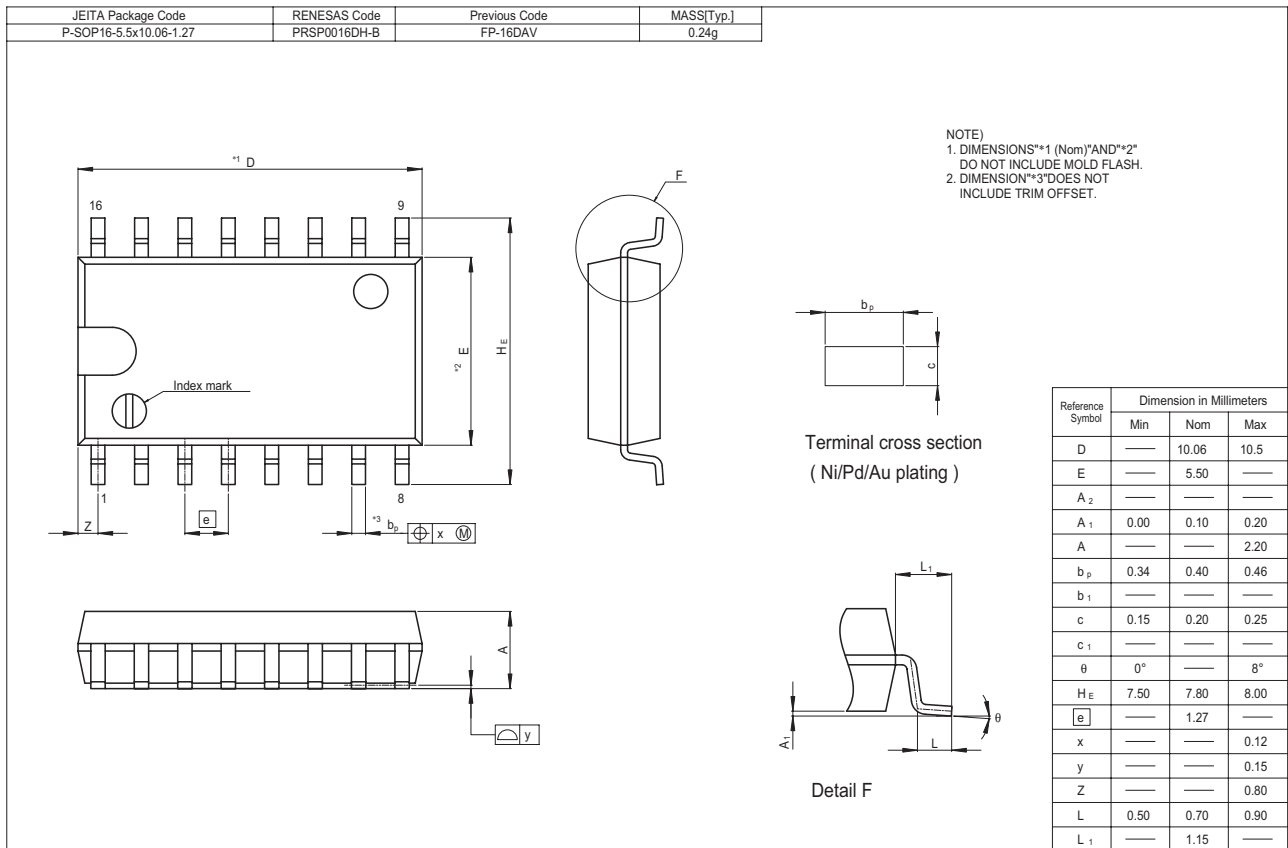
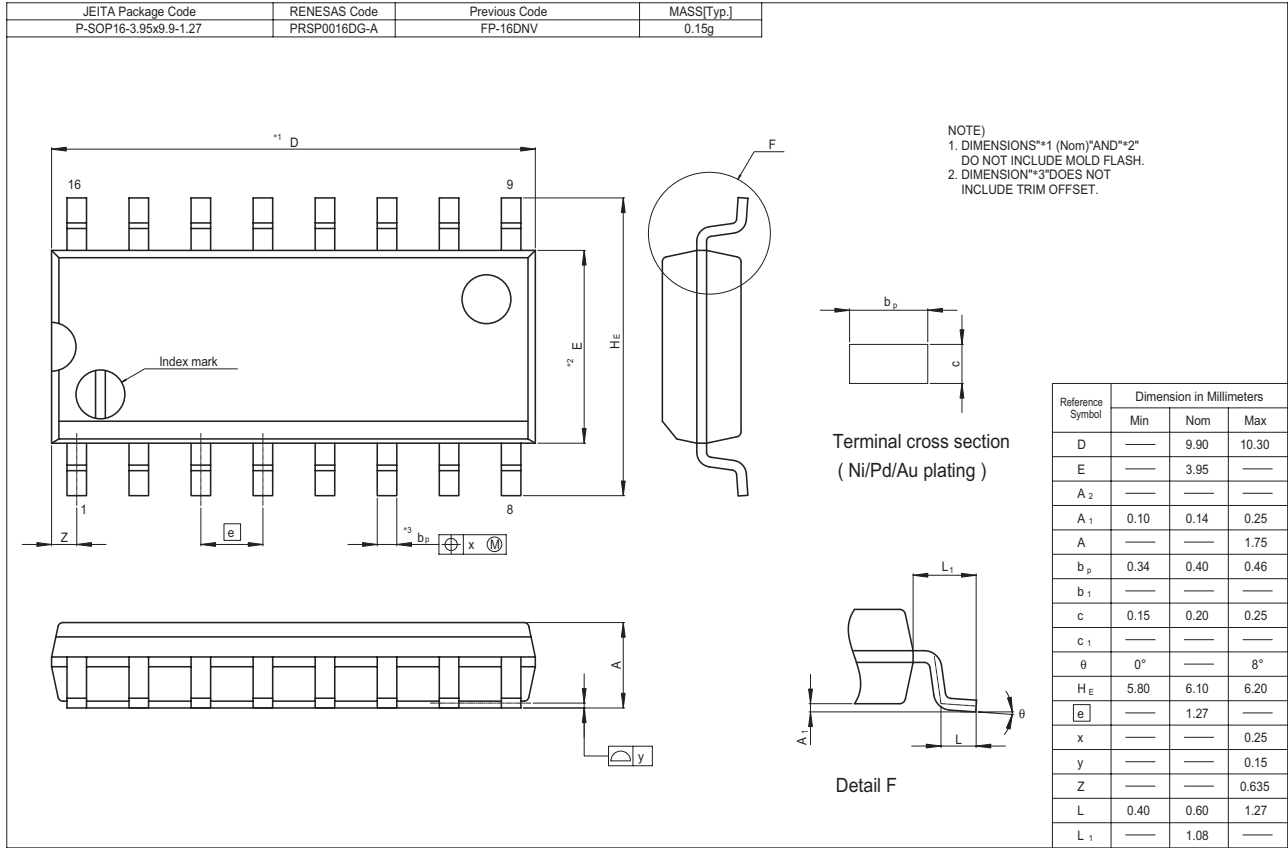
Waveforms



Package Dimensions



Package Dimensions



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